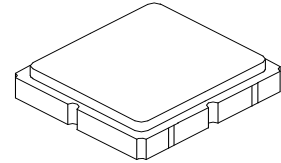


- **RF Filter for GSM900**
- **No Matching Circuit Required**
- **3.0 x 3.0 x 1.3 mm Package**

**SF1184B-1**

**947.5 MHz  
SAW Filter**



**SM3030-6**

**Absolute Maximum Ratings**

Rating	Value	Units
Maximum Input Power	+15	dBm
DC voltage between Terminals	-5 to +5	VDC
Operable Temperature Range	-45 to +125	°C
Specification Temperature Range	-30 to +85	°C

**Electrical Characteristics**

Characteristic	Sym	Notes	Min	Typ	Max	Units			
Nominal Operating Frequency	$f_c$			947.5		MHz			
Passband	Insertion Loss (935~960 MHz)	IL			2.7	3.5	dB		
					Amplitude Ripple (935~960 MHz)	0.6	1.4	dB	
Attenuation	D.C.~871 MHz					50	62.1	dB	
						890~915 MHz	30	43.9	dB
						980~1025 MHz	25	28.6	dB
						1025~2000 MHz	45	54.1	dB
						2000~3000 MHz	20	26.8	dB
VSWR (935~960 MHz)				1.6	2.3	dB			
Temperature Coefficient				-36		ppm/°C			
Impedance at $f_c$ ; Input $Z_{IN}$		1		50		$\Omega$			
Output $Z_{OUT}$		1		50		$\Omega$			

Case Style	SM3030-6 3 x 3 mm Nominal Footprint
Lid Symbolization (YY=year, WW=week, D=day)	459 YYWWD

**Electrical Connections**

Connection	Terminals
Input	2
Output	5
Ground	All others



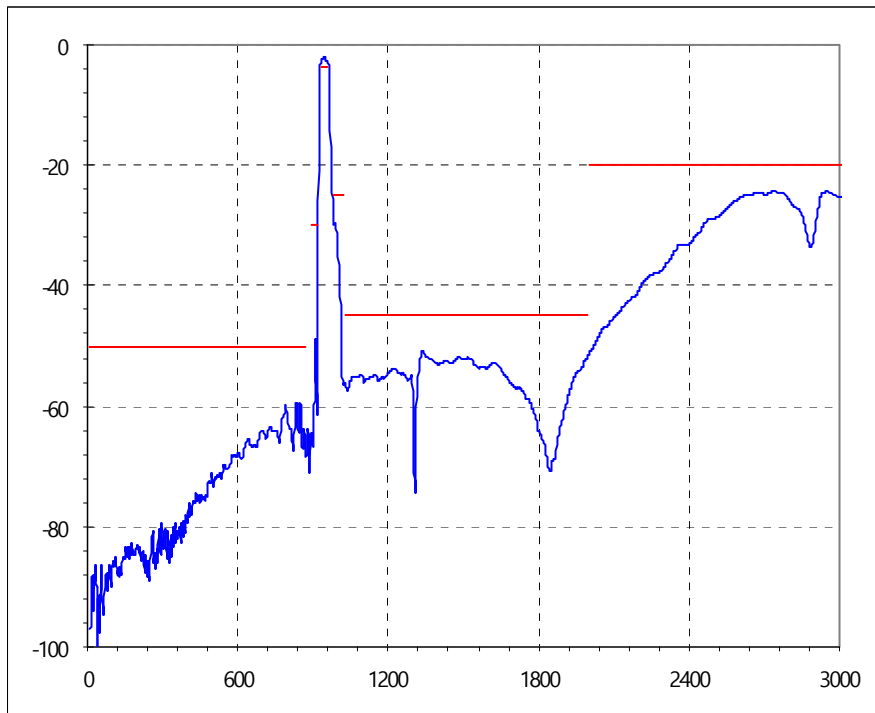
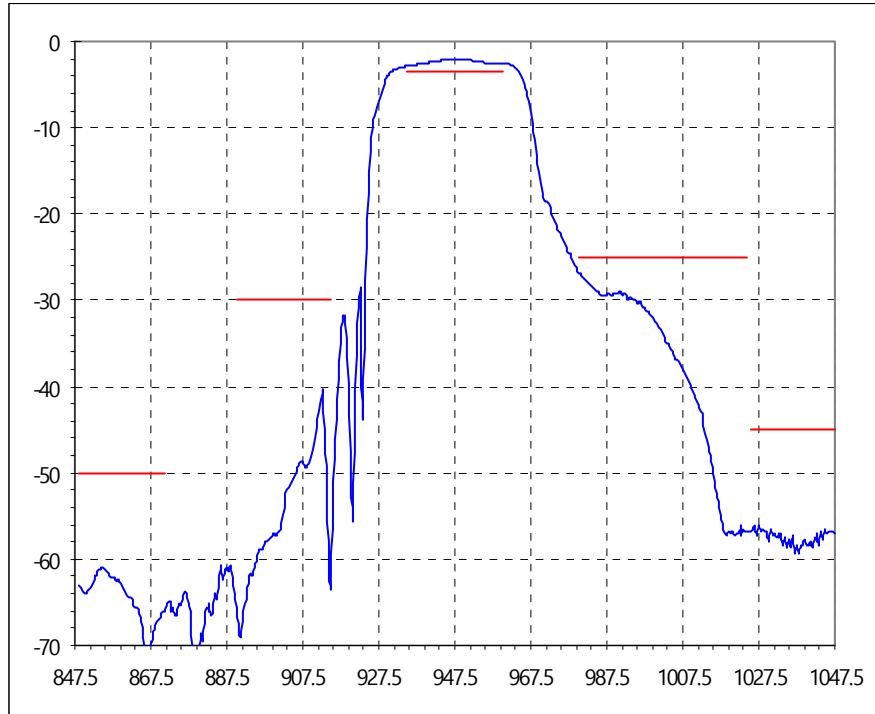
**CAUTION: Electrostatic Sensitive Device. Observe precautions for handling.**

**NOTES:**

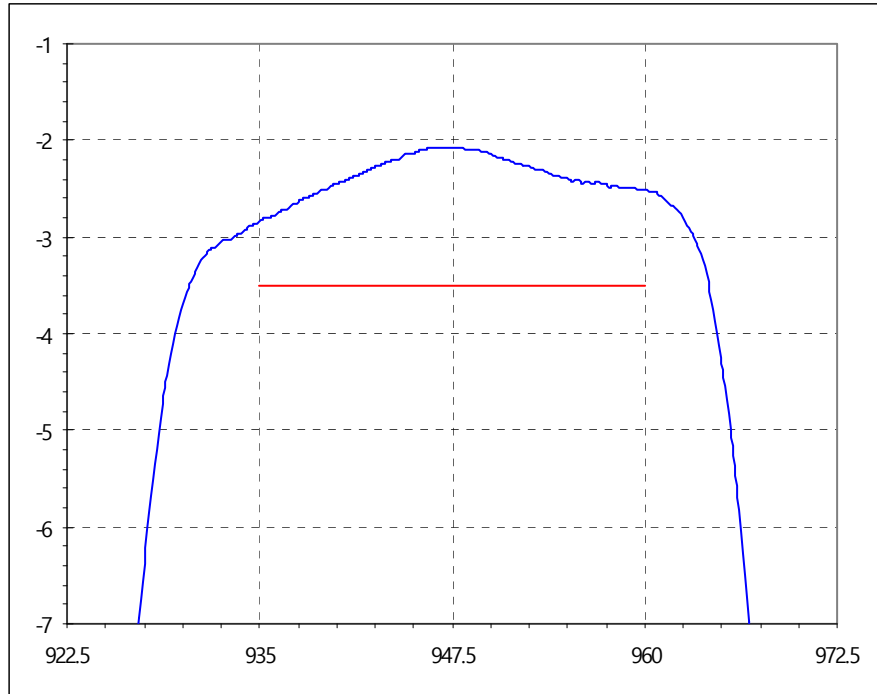
1. Unless noted otherwise, all specifications apply over the operating temperature range with filter soldered to the specified demonstration board with impedance matching to 50  $\Omega$  and measured with 50  $\Omega$  network analyzer.
2. Unless noted otherwise, all frequency specifications are referenced to the nominal center frequency,  $f_c$ .
3. Rejection is measured as attenuation below the minimum IL point in the passband. Rejection in final user application is dependent on PCB layout and external impedance matching design. See Application Note No. 42 for details.
4. "LRIP" or "L" after the part number indicates "low rate initial production" and "ENG" or "E" indicates "engineering prototypes."
5. The design, manufacturing process, and specifications of this filter are subject to change.
6. Either Port 1 or Port 2 may be used for either input or output in the design. However, impedances and impedance matching may vary between Port 1 and Port 2, so that the filter must always be installed in one direction per the circuit design.
7. US and international patents may apply.
8. Murata, stylized Murata logo, and Murata N.A., Inc. are registered trademarks of Murata Manufacturing Co., Ltd.

**FREQUENCY CHARACTERISTICS:**

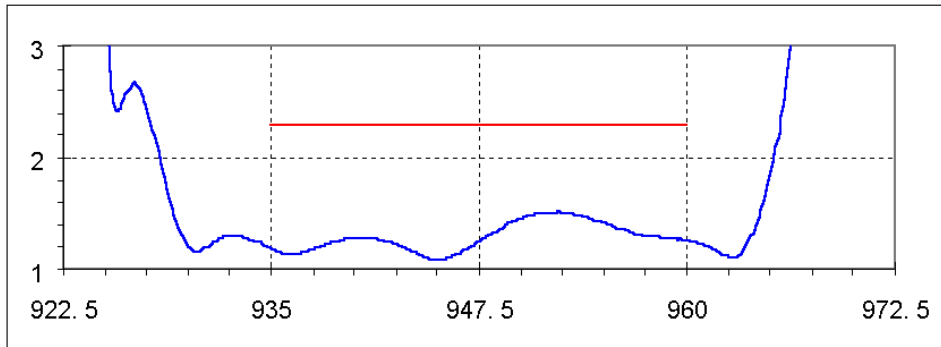
**1. wideband response:**



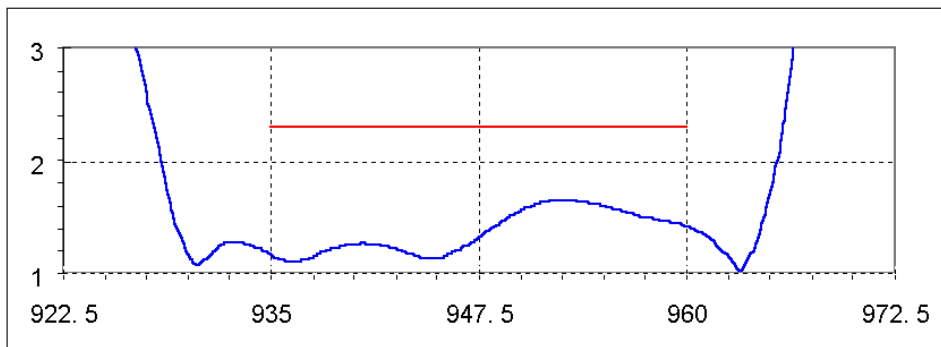
1. passband response:



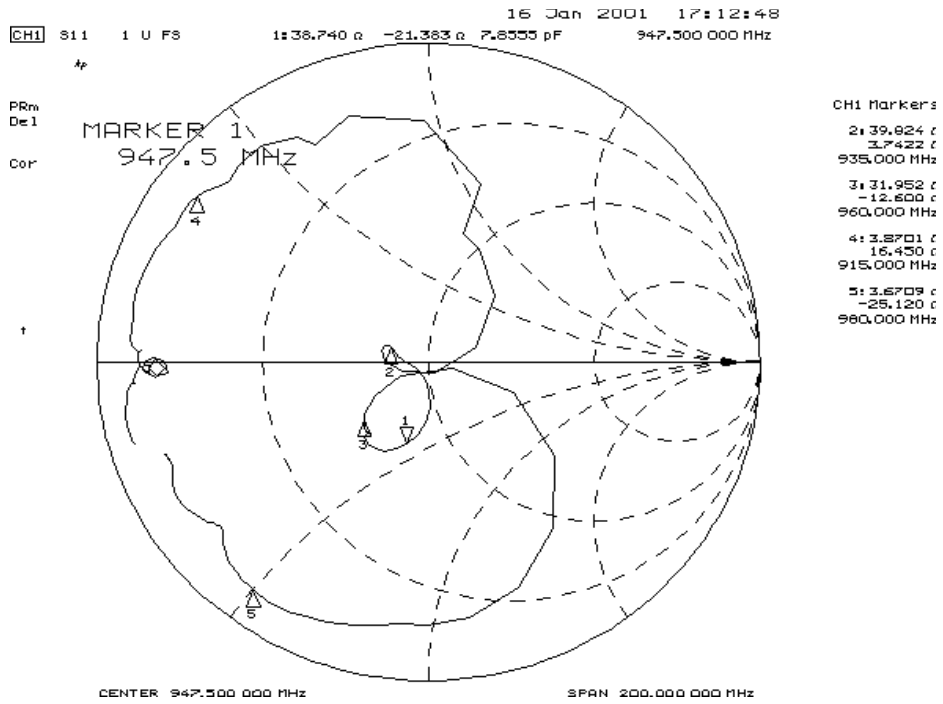
2. VSRW:



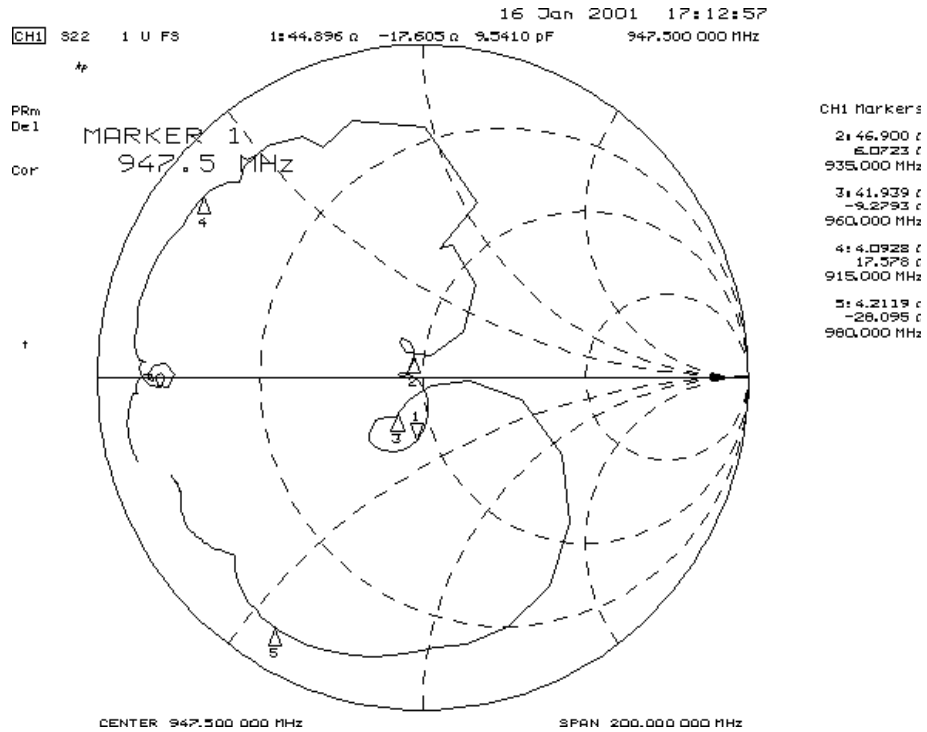
S22



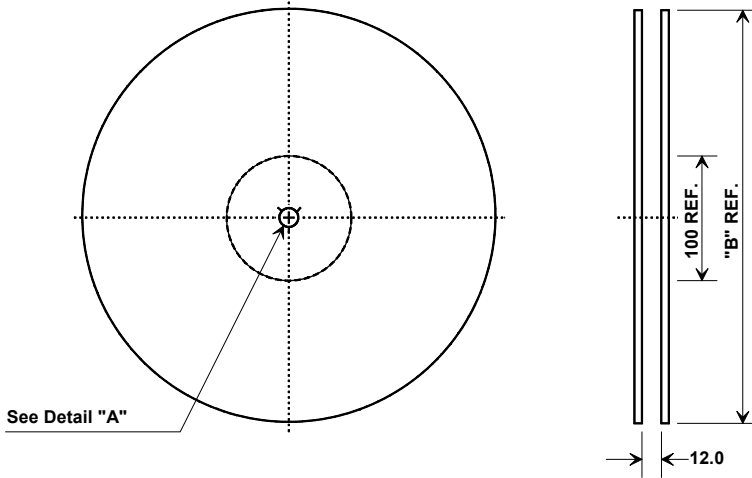
### 3. Smith chart of S11:



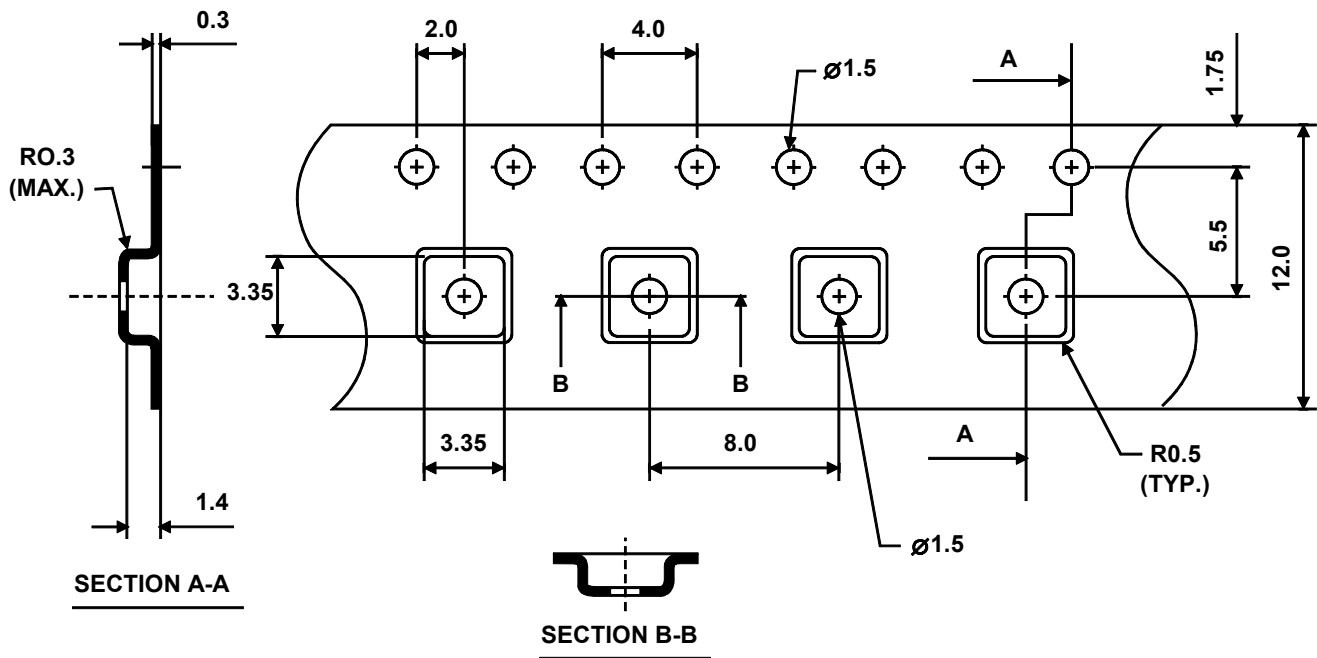
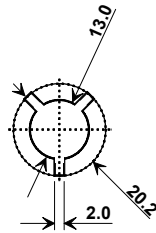
### 4. Smith chart of S22:



# Tape and Reel Specifications

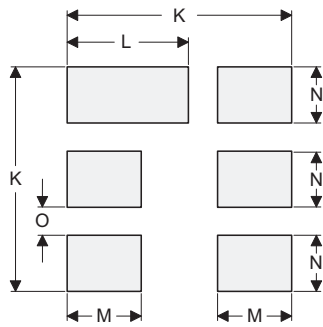
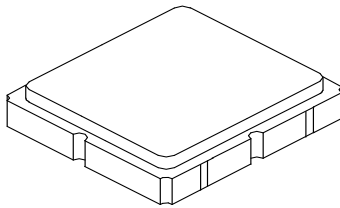


"B" Nominal Size		Quantity Per Reel
Inches	millimeters	
7	178	500
13	330	3000



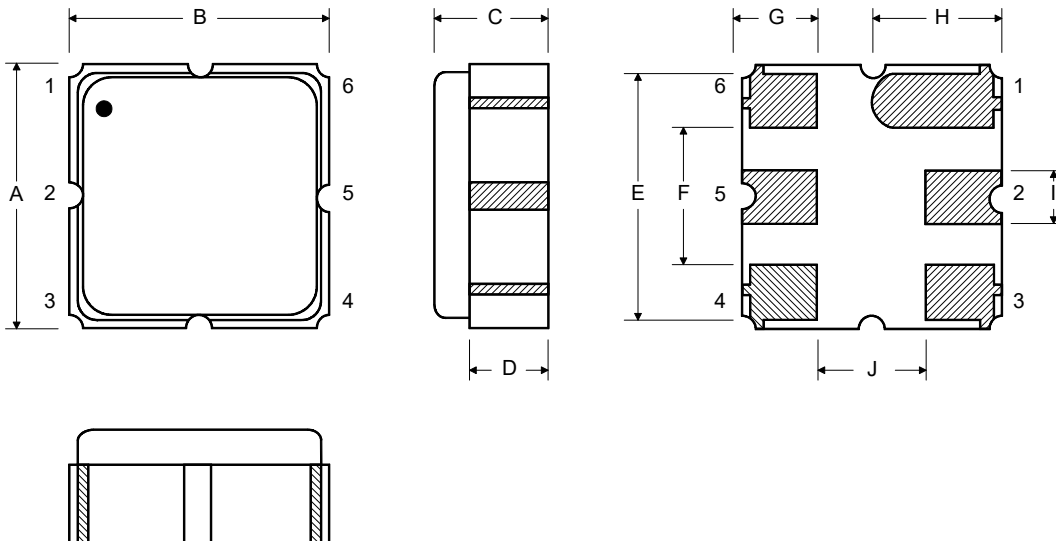
# SM3030-6 Case

## 6-Terminal Ceramic Surface-Mount Case 3.0 X 3.0 mm Nominal Footprint



PCB FOOTPRINT

TOP VIEW



Case and PCB Footprint Dimensions

Dimension	mm			Inches		
	Min	Nom	Max	Min	Nom	Max
A	2.87	3.00	3.13	0.113	0.118	0.123
B	2.87	3.00	3.13	0.113	0.118	0.123
C	1.12	1.25	1.38	0.044	0.049	0.054
D	0.77	0.90	1.03	0.030	0.035	0.040
E	2.67	2.80	2.93	0.105	0.110	0.115
F	1.47	1.60	1.73	0.058	0.063	0.068
G	0.72	0.85	0.98	0.028	0.033	0.038
H	1.37	1.50	1.63	0.054	0.059	0.064
I	0.47	0.60	0.73	0.019	0.024	0.029
J	1.17	1.30	1.43	0.046	0.051	0.056
K		3.20			0.126	
L		1.70			0.067	
M		1.05			0.041	
N		0.81			0.032	
O		0.38			0.015	

Case Materials

Solder Pad Plating	0.3 to 1.0 $\mu\text{m}$ Gold over 1.27 to 8.89 $\mu\text{m}$ Nickel
Lid Plating	2.0 to 3.0 $\mu\text{m}$ Nickel
Body	$\text{Al}_2\text{O}_3$ Ceramic
Pb Free	

BOTTOM VIEW